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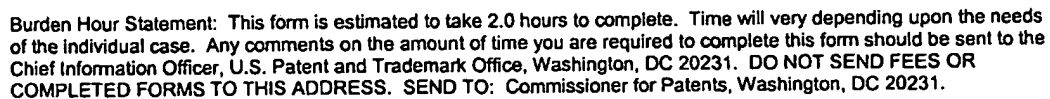
PTO/SB/08A (10-01)

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U.S. Patent and Trademark Office: U.S. DEPARTMENT OF COMMERCE

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Substitute for Form PTO-1449A/PTO		Attorney Docket Number: 1962.EEM		Application No.: 09/966,453	
INFORMATION DISCLOSURE STATEMENT BY APPLICANT (use as many sheets as necessary)		EXAMINER NAME:			
Sheet 1 of 3		First Named Inventor: Osama M. Musa et al.		Group Art:	
Filing Date: 09/28/2001					
U.S. PATENT DOCUMENTS					
*Examiner Initials	Cite No. ¹	Document Number Number - Kind Code ² (if known)	Pub. Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages
CST		US- 3,004,896	10/17/61	H. Heller	
		US-			
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FOREIGN PATENT DOCUMENTS					
*Examiner Initials	Cite No. ¹	Foreign Patent Document Country Code ³ -Number ⁴ -Kind Code ⁵ (if known)	Pub. Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages
CST		FR 1,325,404 /	6/15/62	J. R. Geigy	
		FR 1,330,379 /	6/15/62	J. R. Geigy	
		2,122,465 /	1/17/72	Simonnot et al.	
		DE 197 48 658 A1 /	5/14/98	Ravichandran et al.	
	DDT	EP 0 251 490	5/27/87	J. R. Lawson	
EXAMINER SIGNATURE		DATE CONSIDERED 9/03			
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SHEET 1 OF 7

Form PTO-1449
(REV. 7/80)U.S. Department of Commerce
Patent and Trademark Office

Atty. Docket No. 1962.EEM

Serial No.
09/966,453LIST OF REFERENCES CITED BY APPLICANT
(Use several sheets if necessary)

Applicant: Osama M. Musa

Filing Date: 09/28/01

Group

714

U.S. PATENT DOCUMENTS

*Examiner Initial		Document Number	Date	Name	Class	Subclass	Filing Date if Appropriate
CDT	AA	3,493,539	11/13/68	Skouitchi et al	260	47	
	AB	4,428,987	4/28/82	Bell et al	427	327	
	AC	4,448,847	5/28/82	Bell et al	428	413	
	AD	5,122,858	9/10/90	Mahulikar et al	357	70	
CDT	AE	5,449,951	7/1/94	Parthasarathi et	257	677	
	AF	6,225,378 B1	7/1/99	Wang et al	523	454	
	AG						
	AH						
	AI						
	AJ						
	AK						

FOREIGN PATENT DOCUMENTS

		Document Number	Date	Country	Class	Subclass	Translation	
							Yes	No
CDT	AL	EP 0 251 490 A2	27.05.87	Europe	C0 9J	5/02		
	AM	EP 0 285 266 A2	04.03.88	Europe	C0 8J	5/12		
	AN	EP 0 285 266 A3	04.03.88	Europe	C0 8J	5/12		
CDT	AO	EP 1 033 590 A2	16.02.2000	Europe	G02B	1/04		
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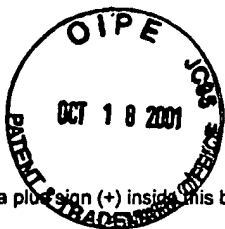
OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, Etc.)

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EXAMINER	DATE CONSIDERED 9/03	

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INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(use as many sheets as necessary)

Sheet 3 of 7

Application Number	09/966,453
Filing Date	09/28/01
First Named Inventor	Osama M. Musa
Group Art Unit	1714
Examiner Name	Toome
Attorney Docket Number	1962.EEM

OTHER PRIOR ART – NON PATENT LITERATURE DOCUMENTS

Examiner Initials*	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item, (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T ²
		No author: NORBLOC – Polymerizable UV Stabilizers	
COF		FOURNIER, T. et al.: "Femtosecond laser studies of excited state intramolecular proton transfer in an ultraviolet – filter molecule"; Chem. Phys. Lett. 2000, 325 (1,2,3), 171-175 (Eng), Elsevier Science B.V.; CA Selects: Siloxanes & Silicones, Issue 23, 2000	
		HUNEKE, JAMES T. et al.: "Die Attach Adhesion on Leadframes Treated with Antioxidants"; Oct. 1997 IEEE/CPMT Electronic Packaging Technology Conf.-Singapore	
		OSTRAUSKAITE, JOLITA et al.: "Synthesis and cationic polymerization of 5-(2,3-epoxypropyl)amino-2-phenyl-1,2,3- benzotriazole"; European Polymer Journal 36 (2000) 2499-2504; Kaunas Univ. of Tech., Kaunas, Lithuania	
		KIM, TAEK HYEON et al.: "Melt Free-Radical Grafting of Hindered Phenol Antioxidant onto Polyethylene"; Journal of Applied Polymer Science, Vol. 77, 2968-2973 (2000); Kwangju, Korea; John Wiley & Sons, Inc. Pub.	
OA		KIM, TAEK HYEON et al.: "Free Radicals Grafting of Hindered Phenol Antioxidants Onto Low Molecular Weight PE"; Polymer Preprints 2000, 41(2), 1237; Kwangju, Korea.	

Examiner Signature #43995		Date Considered	9/03
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INFORMATION DISCLOSURE STATEMENT BY APPLICANT (use as many sheets as necessary) Sheet <u>4</u> of <u>7</u>	Application Number	09/966,453
	Filing Date	09/28/01
	First Named Inventor	Osama M. Musa
	Group Art Unit	1714
	Examiner Name	1714
Attorney Docket Number		1962.EEM

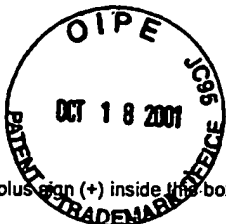
OTHER PRIOR ART – NON PATENT LITERATURE DOCUMENTS			
Examiner Initials*	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item, (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T ²
CT		BARTUS, JAN et al.: "Functional Polymers. 63.* Emulsion Copolymerization of Maleimide Type Monomers With Acrylonitrile And Styrene In ABS Latexes"; J.M.S.-Pure Appl. Chem., A36(3), pp. 355-371 (1999); 1999 by Marcel Dekker, Inc.	
		STOEGER, LUTZ et al.: "Functional Polymers. 64. Potassium Ionization Of Desorbed Species (K ⁺ IDS) Of 2(2-Hydroxyphenyl)2H-Benzotriazoles"; J.M.S.-Pure Appl. Chem., A37(11), pp. 1269-1300 (2000); 2000 by Marcel Dekker, Inc.	
		STOEGER, LUTZ et al.: "Functional Polymers 65. Synthesis And Brief Characterization of Surface Active 2(2-Hydroxyphenyl)2H-Benzotriazole Ultraviolet Stabilizers"; J.M.S.-Pure Appl. Chem., A37(9), pp. 943-970 (2000); 2000 by Marcel Dekker, Inc.	
		NO AUTHOR: Graphs: "A Benzotriazole Family"; "p-Polyhydroxystyrene Family"; TriQuest, LP	
		ACS Registry Database Structure Search, 54 Entries, 66 Pages.	
		KIM, H. et al.: "Corrosion protection and adhesion promotion for polyimide/copper system using silane-modified polymeric materials"; Polymer 41 (2000) 6553-6561, Seoul South Korea	
CT		YU, J. et al.: "Miscibility of Polyimide with Polymeric Primer and Its Influence on Adhesion of Polyimide to the Primed Copper Metal: Effect of Precursor Origin"; Journal of Polymer Science: Part B: Polymer Physics, Vol. 37, 2806-2814 (1999); Pub. John Wiley & Sons, Inc.	

Examiner Signature		Date Considered	9/03
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INFORMATION DISCLOSURE STATEMENT BY APPLICANT (use as many sheets as necessary) Sheet <u>5</u> of <u>7</u>	Application Number	09/966,453
	Filing Date	09/28/01
	First Named Inventor	Osama M. Musa
	Group Art Unit	1714
	Examiner Name	Toomey
Attorney Docket Number		1962.EEM

OTHER PRIOR ART - NON PATENT LITERATURE DOCUMENTS			
Examiner Initials*	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item, (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T ²
CST		ISHIDA, H. et al.: "Modified Imidazoles: Degradation Inhibitors and Adhesion Promoters for Polyimide Films on Copper Substrates"; J. Adhesion, 1991, Vol. 36, pp. 177-191; 1991 Gordon and Breach Science Publishers S.A., U.K.	
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		XUE, GI et al.: "SERS, XPS, and Electroanalytical Studies of the Chemisorption of Benzotriazole on a Freshly Etched Surface and an Oxidized Surface of Copper"; J. Phys. Chem. 1991, 95, 7380-7384.	
CST		YOSHIDA, SHUJI et al.: "A FT-IR Reflection-Absorption Spectroscopic Study of an Epoxy Coating on Imidazole-Treated Copper"; J. Adhesion, 1984, Vol. 16, pp. 217-232; 1984 Gordon & Breach Science Publishers, Inc., U.K.	

Examiner Signature #44037		Date Considered	9/03
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¹ Unique citation designation number. ² Applicant is to place a check mark here if English language Translation is attached.

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INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(use as many sheets as necessary)

Sheet 6 of 7

Application Number	09/966,453
Filing Date	09/28/01
First Named Inventor	Osama M. Musa
Group Art Unit	1714
Examiner Name	Toomey
Attorney Docket Number	1962.EEM

OTHER PRIOR ART – NON PATENT LITERATURE DOCUMENTS

Examiner Initials*	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item, (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T ²
CST		MANSFIELD, FLORIAN et al.: Technical Note "Benzotriazole as Corrosion Inhibitor for Copper II. Acid NaCl Solutions"; Corrosion-Nace, North American Rockwell Science Center, Thousand Oaks, CA; Submitted for publication August, 1972.	-
		VOGT, JURGEN : "Thermoset Matrices for Structural Adhesives: Imidazole-Catalysed Curing of Epoxy Resins"; J. Adhesion, 1987. Vol. 22, pp. 139-151, 1987 Gordon & Breach Science Publishers, Inc., U.K.	-
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		LEE, H. Y. : "Failure paths of the Cu-based leadframe/EMC joints"; Materials Science and Engineering A311 (2001) 217-225; 2001 Elsevier Science B.V.	-
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		HUANG, YIZHE ELISA et al.: "Effect Of Solder Reflow Temperature Profile On Plastic Package Delamination"; 1998 IEEE/CPMT Int'l Electronics Manufacturing Technology Symposium.	-
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Examiner Signature #44092		Date Considered	9/63
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INFORMATION DISCLOSURE STATEMENT BY APPLICANT (use as many sheets as necessary) Sheet <u>7</u> of <u>7</u>	Application Number	09/966,453
	Filing Date	09/28/01
	First Named Inventor	Osama M. Musa
	Group Art Unit	1714
	Examiner Name	Toomey
Attorney Docket Number		1962.EEM

OTHER PRIOR ART – NON PATENT LITERATURE DOCUMENTS			
Examiner Initials*	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item, (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T ²
COT		SCHMIDT, R. et al.: "Investigation of the Adhesion Strength between Molding Compound and Leadframe at Higher Temperatures"; 1998 IEEE/CPMT Electronics Packaging Technology Conference.	
		GAILLARD, F. et al.: "Grazing-angle Micro-FTIR Spectroscopy (GAM-FTIR): Applications to Adhesion Studies"; Surf. Interface Anal. 27, 865-870 (1999); John Wiley & Sons, Ltd.	
		ALPERN, P. et al.: "A simple model for the mode I popcorn effect for IC packages"; Microelectronics Reliability 40 (2000) 1503-1508; 2000 Elsevier Science Ltd. All rights reserved.	
		YU, SHAN-PU et al.: "The Adhesion Strength of A Lead-Free Solder Hot-Dipped on Copper Substrate"; Journal of ELECTRONIC MATERIALS, Vol. 29, No. 2, 2000.	
COT		H. DEBONTRIDE et al.: "Study of chromating layers on zinc coated steel using FTIR and Raman spectroscopies: application to adhesion properties"; La Revue de Metallurgie-CIT Science et Genie des Matériaux, March 1995.	

Examiner Signature #44097		Date Considered	9/03
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SHEET 2 OF 7

Form PTO-1449 (REV. 7/80)		U.S. Department of Commerce Patent and Trademark Office		Atty. Docket No. 1962.EEM		Serial No. 09/966,453		
LIST OF REFERENCES CITED BY APPLICANT (Use several sheets if necessary)				Applicant: Osama M. Musa				
				Filing Date: 09/28/01		Group 1714		
U.S. PATENT DOCUMENTS								
*Examiner Initial		Document Number	Date	Name	Class	Subclass	Filing Date if Appropriate	
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	AB							
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	AD							
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	AH							
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FOREIGN PATENT DOCUMENTS								
		Document Number	Date	Country	Class	Subclass	Translation	
							Yes	No
CPT	AL	Hei 11-[1999]-196,722 -	07/9/99	Japan				
	AM	Hei 11-[1999]-195,358 -	07/9/99	Japan				
	AN	Hei 11-[1999]-285,892 -	10/06/99	Japan				
	AO	VV M 814/6.76 -	unknown	Germany				
QD1	AP	DE 44 36 355 A 1 -	unknown	Germany				
OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, Etc.)								
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EXAMINER				DATE CONSIDERED 9/03				
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INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(use as many sheets as necessary)

Sheet 2 of 3

Attorney Docket Number: 1962.EEM

Application No.: 09/966,453

EXAMINER NAME:

First Named Inventor: Osama M. Musa et al.

Filing Date: 09/28/2001

Group Art: 171X

U.S. PATENT DOCUMENTS

*Examiner Initials	Cite No. ¹	Document Number Number - Kind Code ² (if known)	Pub. Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document			Pages
		US-					
		US-					
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FOREIGN PATENT DOCUMENTS

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CDT		EP 0 285 266	4/3/88	J. R. Lawson			
		EP 0 431 868 /	3/12/90	A. Gupta			
		EP 0 736 577 /	3/25/96	K. L. Lilly			
		EP 0 970 946 /	1/7/99	R. A. Schultz et al.			
CDT		EP 1 033 590	2/16/00	A. Okumura			

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Sheet 3 of 3				EXAMINER NAME:			
				First Named Inventor: Osama M. Musa et al.			
Filing Date: 09/28/2001				Group Art: 1714			

U.S. PATENT DOCUMENTS							
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*Examiner Initials	Cita No. ¹	Foreign Patent Document Country Code ³ -Number ⁴ -Kind Code ⁵ (if known)	Pub. Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document			Pages
		FR 1,330,378 /	6/15/62	J. R. Geigy			
		JP 2000096032 /	4/4/2000	A. Akata			

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